Low phase noise LO generator for VSAT applications Rev. 2 — 14 April 2011 Product

Product data sheet

General description 1.

The TFF11084HN is a K_u band frequency generator intended for low phase noise Local Oscillator (LO) circuits for Ku band VSAT transmitters and transceivers. The specified phase noise complies with IESS-308 from Intelsat.

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

Features and benefits 2.

- Phase noise compliant with IESS-308 (Intelsat) in combination with appropriate source
- LO generator with VCO range from 8.20 GHz to 8.60 GHz
- Input signal 32 MHz to 538 MHz
- Divider settings 16, 32, 64, 128 or 256
- Output level –4 dBm; stability ±2 dB
- Third or fourth order PLL
- Internally stabilized voltage references for loop filter

Applications 3.

VSAT up converters

Local oscillator signal generation

Quick reference data 4.

Quick reference data Table 1. Operating conditions of Table 10 apply.

| , , | | | | | | |
|---------------------------------|--------------------------------|--|------|-----|------|--------|
| Symbol | Parameter | Conditions | Min | Тур | Мах | Unit |
| V _{CC} | supply voltage | | 3.0 | 3.3 | 3.6 | V |
| I _{CC} | supply current | | - | 100 | 130 | mA |
| f _{o(RF)} | RF output frequency | | 8.20 | - | 8.60 | GHz |
| $\phi_{\text{n}(\text{synth})}$ | synthesizer phase noise | divider value = 64; at 100 kHz offset; reference phase noise is -149 dBc/Hz at 100 kHz offset | - | -97 | -92 | dBc/Hz |
| RL _{out} | output return loss | measured at demo board and de-embedded to footprint | - | -10 | - | dB |
| $\alpha_{sup(sp)ref}$ | reference spurious suppression | measured at divider value = 256 | - | - | -70 | dBc |
| | | | | | | |



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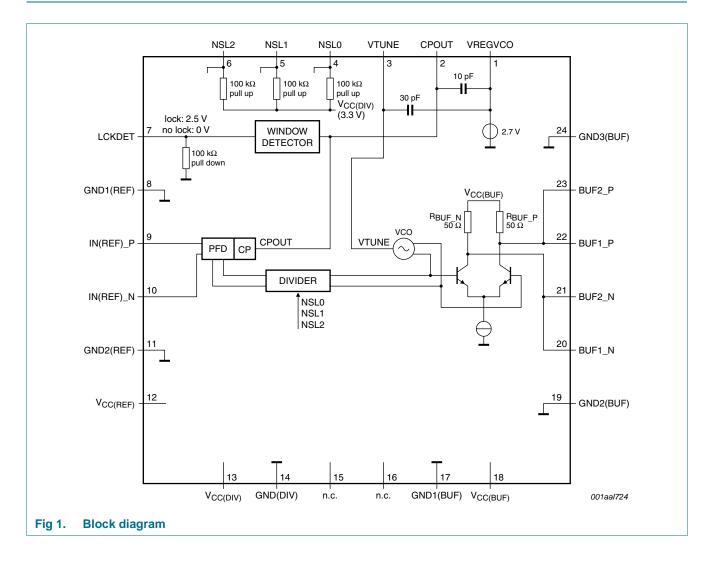
5. Ordering information

| Table 2. Ordering information | | | | | | | | |
|---------------------------------------|---------|--|----------|--|--|--|--|--|
| Type number Package | | | | | | | | |
| | Name | Description | Version | | | | | |
| TFF11084HN | HVQFN24 | plastic thermal enhanced very thin quad flat package; no leads; 24 terminals; body $4 \times 4 \times 0.85$ mm | SOT616-1 | | | | | |

6. Marking

| Table 3. Marking codes | |
|--------------------------|--------------|
| Type number | Marking code |
| TFF11084HN | T084 |

7. Block diagram

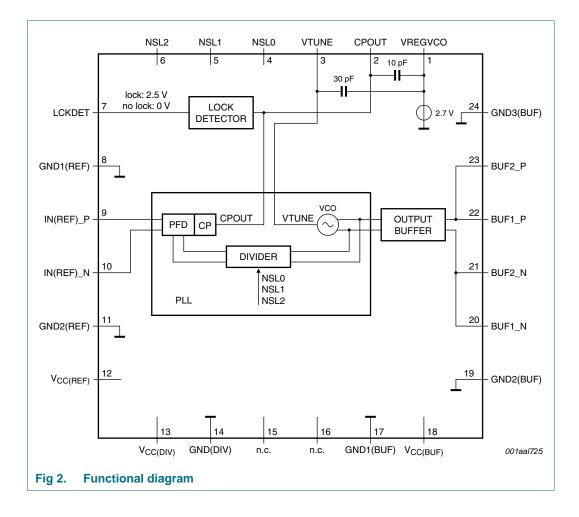


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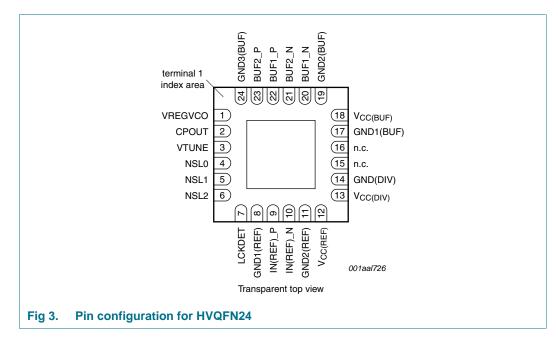
8. Functional diagram



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9. Pinning information

9.1 Pinning



9.2 Pin description

| Symbol | Pin | Description |
|----------------------|-----|--|
| VREGVCO | 1 | Regulated output voltage for VCO loop filter. Connect loop filter to this pin. |
| CPOUT | 2 | Charge pump output. |
| VTUNE | 3 | Tuning voltage for VCO. |
| NSL0 | 4 | Divider setting, LSB. Leave open for "1", connect to GND for "0". See <u>Table 8</u> . |
| NSL1 | 5 | Divider setting. Leave open for "1", connect to GND for "0". See <u>Table 8</u> . |
| NSL2 | 6 | Divider setting, MSB. Leave open for "1", connect to GND for "0". See Table 8 |
| LCKDET | 7 | Lock detect. Lock = 2.5 V; out of lock = 0 V. See <u>Table 6</u> . |
| GND1(REF) | 8 | Ground for REF input. Connect this pin to the exposed diepad landing. |
| IN(REF)_P | 9 | Reference signal, non-inverting input. Couple this AC to the source. |
| IN(REF)_N | 10 | Reference signal, inverting input. Couple this AC to the source. |
| GND2(REF) | 11 | Ground for REF input. Connect this pin to the exposed diepad landing. |
| $V_{CC(REF)}$ | 12 | Supply of the internal regulated voltages. Decouple this pin against GND2(REF) (pin 11). |
| V _{CC(DIV)} | 13 | Supply of the divider and PFD/CP. Decouple this pin against GND(DIV) (pin 14). |
| GND(DIV) | 14 | Ground of the divider. Connect this pin to the exposed diepad landing. |
| n.c. | 15 | not connected |
| n.c. | 16 | not connected |
| GND1(BUF) | 17 | Ground for RF output. Connect this pin to the exposed diepad landing. |

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| Table 4. F | Pin de | scriptioncontinued |
|----------------------|--------|--|
| Symbol | Pin | Description |
| V _{CC(BUF)} | 18 | Supply voltage for the RF output buffer. Decouple this pin against GND2(BUF) (pin 19). |
| GND2(BUF) | 19 | Ground for RF output. Connect this pin to the exposed diepad landing. |
| BUF1_N | 20 | RF output. |
| BUF2_N | 21 | RF output. |
| BUF1_P | 22 | RF output. |
| BUF2_P | 23 | RF output. |
| GND3(BUF) | 24 | Ground for RF output. Connect this pin to the exposed diepad landing. |

10. Functional description

The TFF11084HN consists of the following blocks:

- PLL
- Output buffer
- Lock detector
- Reference input
- Divider settings

The functionality of the blocks will be discussed below.

10.1 PLL

The PLL is formed by the VCO, DIVIDER (possible settings: 16, 32, 64, 128 and 256 (see <u>Table 8</u>)) and a PFD/CP. The tune voltage is referred to the band gap regulated voltage: VREGVCO (pin 1).

The loop filter can be set to type 2 or type 3. If a type 2 filter is used, the pins CPOUT (pin 2) and VTUNE (pin 3) must be interconnected. A 10 pF capacitor is placed internally between pins CPOUT (pin 2) and VREGVCO (pin 1), and a 30 pF capacitor is placed between pins VTUNE (pin 3) and VREGVCO (pin 1). See <u>Figure 4</u> and <u>Figure 5</u>. Values for the loop filter components are given in <u>Table 5</u>.

The VCO input voltage range is between 0.1 and 0.9 $V_{O(reg)VCO}$.

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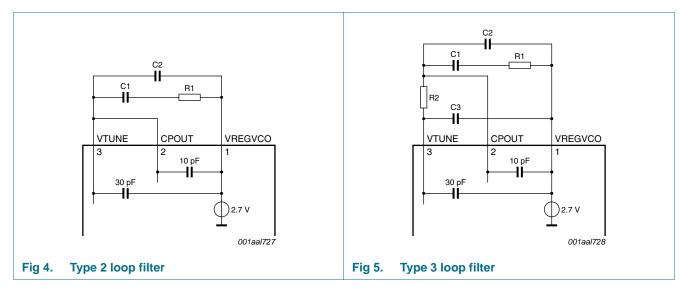


Table 5. Component values used for characterization

| f _{i(ref)} | Divider value | C1 | C2 | C3 | R1 | R2 |
|---------------------|---------------|------|------|------|---------------------|---------------------|
| (MHz) | | (nF) | (pF) | (pF) | (Ω) | (Ω) |
| 32.031 to 33.594 | 256 | 27 | 82 | 33 | 470 | 560 |
| 64.063 to 67.188 | 128 | 18 | 82 | 33 | 330 | 560 |
| 128.125 to 134.375 | 64 | 18 | 120 | 33 | 270 | 560 |
| 256.250 to 268.750 | 32 | 33 | 270 | 33 | 120 | 560 |
| 512.500 to 537.500 | 16 | 68 | 560 | 33 | 68 | 560 |

10.2 Output buffer

The output consists of a differential pair with 50 Ω collector resistors R_{BUF_P} and R_{BUF_N}. If only one output is used, terminate the non used output with the same impedance as the load (see Figure 8)

10.3 Lock detector

The lock detector is the output of a window detector. The window detector compares the output voltage over the charge pump. This voltage is identical to VTUNE when a type 2 loop filter is used (see <u>Figure 4</u>). In case of a type 3 loop filter this voltage is filtered by R2/C3 (see <u>Figure 5</u>). Due to this filtering the attack and decay time will decrease.

The lower window detector threshold voltage is 7 % of the output voltage on VREGVCO (pin 1), the upper window detector threshold voltage is 93 % of the output voltage on VREGVCO (pin 1). The hysteresis is 0.1 V. The output is 2.5 V CMOS compliant. The values are shown in <u>Table 6</u>. The timing diagram is shown in <u>Figure 6</u>.

At start-up the LCKDET (pin 7) will be LOW until the circuit has acquired lock.

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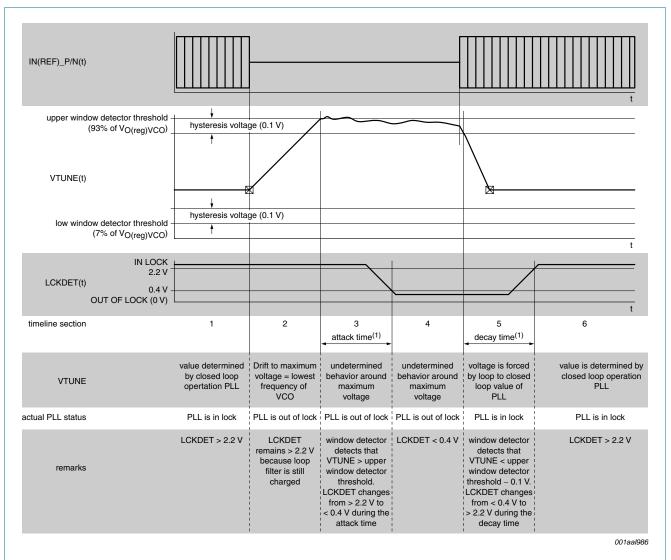
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 Table 6.
 Logical value and physical value for lock detect (LCKDET)

| Logical value | Physical value | Lock detect state |
|---------------|----------------|-------------------|
| 0 | 0 V | out of lock |
| 1 | 2.5 V | lock |

LCKDET (pin 7) has a pull-down resistor of 100 k Ω to GND1(REF) (pin 8).



(1) The attack time and decay time are typically 10 µs and are mainly depending on the drift of the VCO tuning voltage.

Fig 6. Timing diagram lock detector

10.4 Reference input (IN(REF)_P, IN(REF)_N)

AI

The reference input is a differential pair and is internally biased. The input is high ohmic. The input signal must be AC coupled. If used in a single ended mode, the not used input must be terminated with the same impedance as the driving source.

An example of the differential source and two single ended loads are shown in <u>Figure 7</u>. An example of a single ended application is shown in <u>Figure 8</u>.

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Note that the phase noise of the output signal is also determined by the phase noise of the reference signal. The reference frequency range is equal to the output frequency / division value. Note that the output frequency is guaranteed from 8.20 GHz to 8.60 GHz.

10.5 Divider settings (NSL2, NSL1, NSL0)

The divider can be set to 16, 32, 64, 128 and 256 (See <u>Table 8</u>). The logic levels for NSL0 (pin 4), NSL1 (pin 5) and NSL2 (pin 6) are given in <u>Table 7</u>.

The pins have a pull-up resistor of 100 k Ω to V_{CC(DIV)} (pin 13).

The device is only guaranteed when NSL2, NSL1 and NSL0 are predefined at start-up (no change of divider value is allowed during operation).

Table 7. Logical and physical value for divider setting (NSL2, NSL1, NSL0)

| Logical value | Physical value |
|---------------|-------------------------|
| 0 | GND |
| 1 | open or V _{CC} |

The truth table is shown in Table 8.

Table 8.Divider setting as function of NSL2, NSL1 and NSL0

| Setting number | NSL2 | NSL1 | NSL0 | Divider value |
|----------------|------|------|------|---------------|
| 0 | 0 | 0 | 0 | 16 |
| 1 | 0 | 0 | 1 | 32 |
| 2 | 0 | 1 | 0 | 64 |
| 3 | 0 | 1 | 1 | 128 |
| 4 | 1 | 0 | 0 | 256 |
| 5 | 1 | 0 | 1 | <u>[1]</u> |
| 6 | 1 | 1 | 0 | <u>[1]</u> |
| 7 | 1 | 1 | 1 | <u>[1]</u> |

[1] Test mode, divider output will be disabled.

11. Limiting values

Table 9. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|----------------------|--------------------------|------------|------|------|------|
| V _{CC(REF)} | reference supply voltage | | -0.5 | +3.6 | V |
| V _{CC(DIV)} | divider supply voltage | | -0.5 | +3.6 | V |
| V _{CC(BUF)} | buffer supply voltage | | -0.5 | +3.6 | V |
| Tj | junction temperature | | -40 | +125 | °C |
| T _{stg} | storage temperature | | -40 | +125 | °C |

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12. Recommended operating conditions

Table 10. Operating conditions

NSL0 (pin 4), NSL1 (pin 5) and NSL2 (Pin 6) not changed during operation. Loop filter component values as depicted in <u>Table 5</u> are used.

| - | • | | | | | | |
|---------------------|---------------------------|--|-----|-----|-----|------|--------|
| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
| T _{amb} | ambient temperature | | | -40 | +25 | +85 | °C |
| Z ₀ | characteristic impedance | | | - | 50 | - | Ω |
| φn(ref) | reference phase noise | divider value = 16 | [1] | - | - | -134 | dBc/Hz |
| | | divider value = 32 | [1] | - | - | -143 | dBc/Hz |
| | | divider value = 64 | [1] | - | - | -149 | dBc/Hz |
| | | divider value = 128 | [1] | - | - | -150 | dBc/Hz |
| | | divider value = 256 | [1] | - | - | -151 | dBc/Hz |
| f _{i(ref)} | reference input frequency | $f_{i(ref)} = f_{o(RF)} / divider value$ | | 32 | - | 538 | MHz |
| P _{i(ref)} | reference input power | | | -10 | - | 0 | dBm |
| | | | | | | | |

[1] Required reference phase noise is set 10 dB below equivalent input phase noise.

13. Thermal characteristics

| Table 11. | Thermal characteristics | | | |
|-----------------------|--|------------|-----|------|
| Symbol | Parameter | Conditions | Тур | Unit |
| R _{th(j-sp)} | thermal resistance from junction to solder point | | 25 | K/W |

14. Characteristics

Table 12. Characteristics

Operating conditions of Table 10 apply.

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|------------------------|---|---|-----|--------------------|------|-------------------|--------|
| V _{CC} | supply voltage | | | 3.0 | 3.3 | 3.6 | V |
| I _{CC} | supply current | | | - | 100 | 130 | mA |
| PLL | | | | | | | |
| f _{o(RF)} | RF output frequency | | | 8.20 | - | 8.60 | GHz |
| V _{O(reg)VCO} | VCO regulator output voltage | | | 2.5 | 2.7 | 2.9 | V |
| I _{cp} | charge pump current | | | - | 1 | - | mA |
| Ko | VCO steepness | | [1] | - | 0.6 | - | GHz/V |
| Φn(VCO) | VCO phase noise | at 10 MHz offset | | - | -130 | - | dBc/Hz |
| Φn(synth) | synthesizer phase noise | divider value = 64; at 100 kHz offset; reference phase noise is –149 dBc/Hz at 100 kHz offset | | - | -97 | -92 | dBc/Hz |
| Output buf | fer | | | | | | |
| Po | output power | measured single ended | [2] | -6 | -4 | -2 | dBm |
| RL _{out} | output return loss | measured at demo board and de-embedded to footprint | | - | -10 | - | dB |
| $lpha_{sup(sp)ref}$ | reference spurious suppression | measured at divider value = 256 | | - | - | -70 | dBc |
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| Product data | shoot | Rev. 2 — 14 April 2011 | 0 | | | 9 of ² | |

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Table 12. Characteristics ...continued

Operating conditions of <u>Table 10</u> apply.

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|--------------------|---------------------------|------------------------|-----|-----|-----|------|
| α _{H(LO)} | LO harmonic rejection | | - | -10 | - | dBc |
| Lock deter | ctor | | | | | |
| V _{OL} | LOW-level output voltage | I _O = 1 mA | - | - | 0.4 | V |
| V _{OH} | HIGH-level output voltage | I _O = -1 mA | 2.2 | - | - | V |
| R _{pd} | pull-down resistance | | 70 | 100 | 130 | kΩ |
| Divider set | tting (NSL0, NSL1, NSL2) | | | | | |
| R _{pu} | pull-up resistance | | 70 | 100 | 130 | kΩ |
| V _{IL} | LOW-level input voltage | | - | - | 0.8 | V |
| V _{IH} | HIGH-level input voltage | | 2.0 | - | - | V |

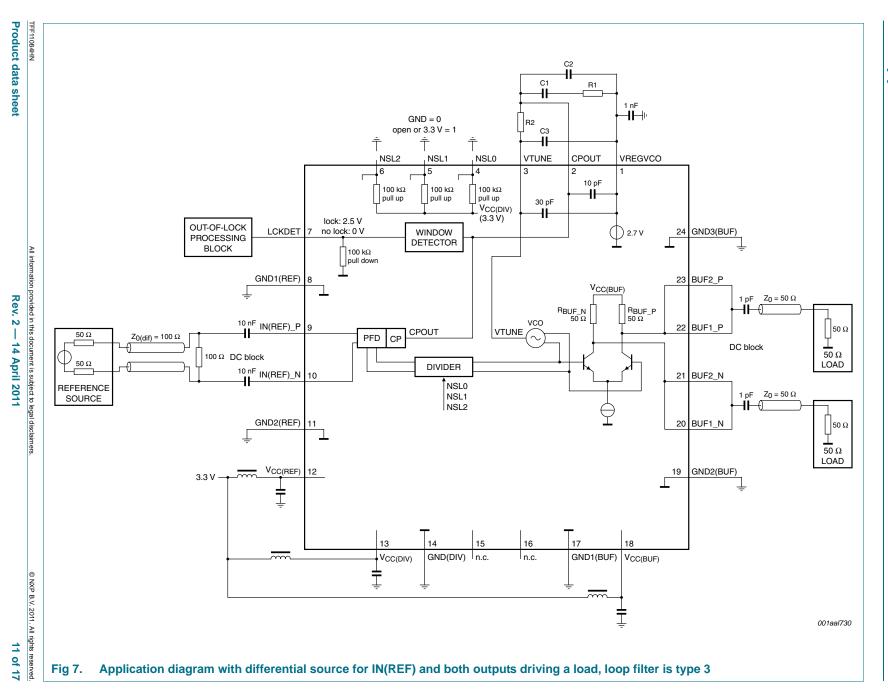
[1] The typical ratio of the maximum K_0 in relation to the minimum K_0 is 1.25.

[2] Output stage is a differential pair with 50 Ω collector impedances.
 Output power is measured per output pin for the fundamental tone only.
 Output is DC coupled and is AC coupled in on-board.



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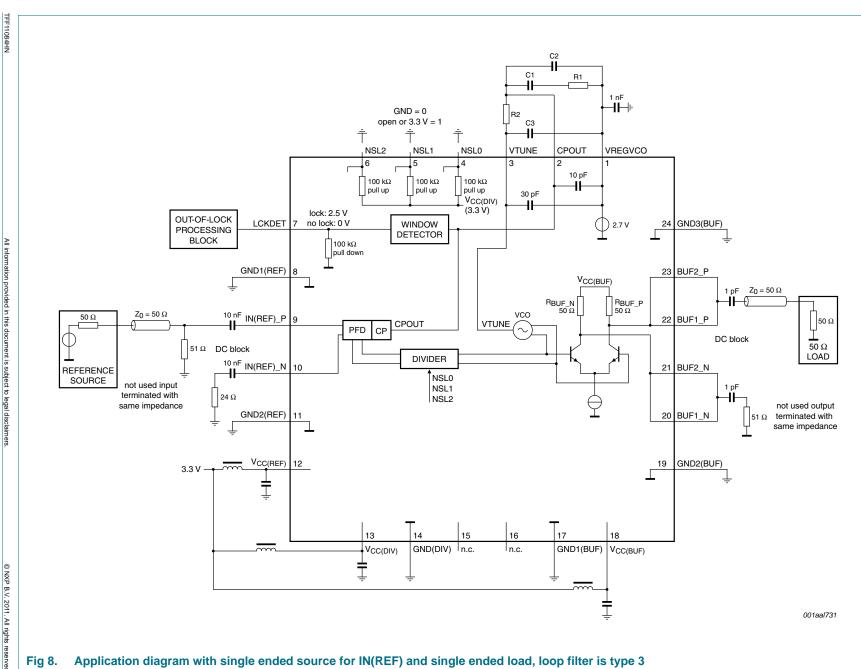
15. Application information



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16. Package outline

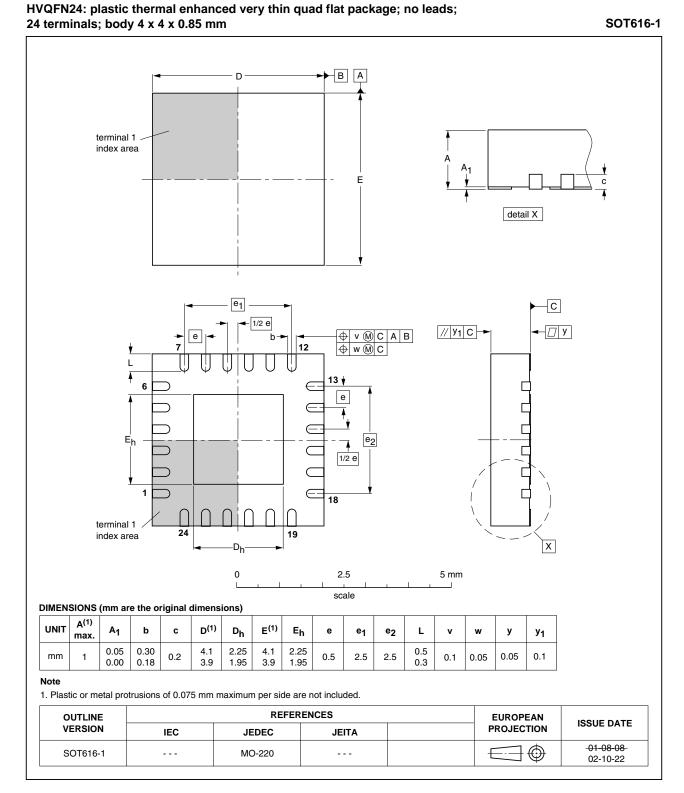


Fig 9. Package outline SOT616-1 (HVQFN24)

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Low phase noise LO generator for VSAT applications

17. Abbreviations

| Table 13. | Abbreviations |
|--------------|---|
| Acronym | Description |
| CMOS | Complementary Metal Oxide Semiconductor |
| CP | Charge Pump |
| K_{u} band | K-under band |
| LSB | Least Significant Bit |
| MSB | Most Significant Bit |
| PFD | Phase Frequency Detector |
| PLL | Phase-Locked Loop |
| VCO | Voltage Controlled Oscillator |
| VSAT | Very Small Aperture Terminal |

18. Revision history

| Table 14. Revision h | istory | | | |
|----------------------|---|---|----------------------------------|----------------|
| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| TFF11084HN v.2 | 20110414 | Product data sheet | - | TFF11084HN v.1 |
| Modifications: | Section 2 or Table 12 on | of this data sheet has been <u>page 1</u> : Output level has <u>page 9</u> : The value for K _O I <u>page 9</u> : The value for P _O h | been changed nas been changed | a sheet |
| TFF11084HN v.1 | 20100712 | Objective data sheet | - | - |

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| Document status[1][2] | Product status ^[3] | Definition |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
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[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions"

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